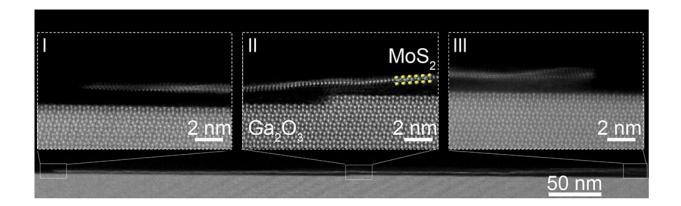


Peel-apart surfaces drive transistors to the ledge

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This cross-section view shows the long and monolayer MoS_2 nanoribbon on top of the ledge of Ga_2O_3 substrate. Credit: 2020 KAUST

Semiconductor manufacturers are paying more attention to twodimensional materials, such as transition metal dichalcogenides (TMDs), following the discovery, at KAUST, of an epitaxial growth process of single-crystal TMDs nanoribbons.

An emerging trend in <u>transistor design</u> involves space-saving architectures that stack components on top of one other. TMDs have potential for these systems because they readily form into thin sheets, known as nanoribbons, which have electrical, optical and magnetic activity. However, typical semiconductor processes, such as photolithography, require complicated procedures to produce TMDs of



sufficient quality for device purposes.

In collaboration with researchers in the U.S., Belgium and Taiwan, Vincent Tung and colleagues at KAUST are developing alternative approaches to TMD fabrication using surface templates to direct singlecrystal growth.

While analyzing candidates with high-resolution electron microscopy, researcher Areej Aljarb spotted something unusual about a semiconductor named gallium trioxide (Ga_2O_3). After peeling off layers of the flaky material using sticky tape, she saw arrays of narrow, terrace-like ledges that stepped up or down the entire Ga_2O_3 surface.

"The steps are very steep and well-exposed," says Aljarb. "And because the atoms located near the vicinity of these ledges have asymmetric structures, they can drive growth in specific directions."

When the team exposed Ga_2O_3 surfaces to a mix of molybdenum and sulfur gas, they observed that TMD nanoribbons crystallized lengthwise along the ledges with structures that were practically defect free. Microscopy experiments and <u>theoretical models</u> revealed that the ledge atoms had unique energetic features that enabled aligned nucleation to form single-crystal nanoribbons. "For decades, scientists have sought to grow 2-D single-crystal semiconductors on insulators, and this work demonstrates that controlling the ledges of the substrate is the key," says Tung.

Intriguingly, the nanoribbons could be pulled off and transferred to other substrates without damaging them. To explore potential applications of the ledge-directed growth technology, the international group joined together to design a transistor capable of incorporating nanoribbons from the Ga_2O_3 template. Electronic measurements showed the new transistor could operate at <u>high speeds</u> and had amplification factors similar to



TMD materials produced through more labor-intensive techniques.

"The nanoribbons grow along the ledges using weak physical interactions to stay in place, meaning that no chemical bonds form between the TMD and the underlying Ga_2O_3 substrate," notes Aljarb. "This unique feature enables us to transfer the nanoribbons onto foreign substrates for many applications, ranging from transistors, sensors, artificial muscles and atomically thin photovoltaics."

More information: Areej Aljarb et al, Ledge-directed epitaxy of continuously self-aligned single-crystalline nanoribbons of transition metal dichalcogenides, *Nature Materials* (2020). DOI: 10.1038/s41563-020-0795-4

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